preliminary

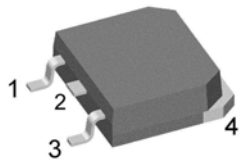
XPT IGBT

V_{CES} = 1200V
I_{C25} = 9A
$V_{CE(sat)}$ = 1.8V

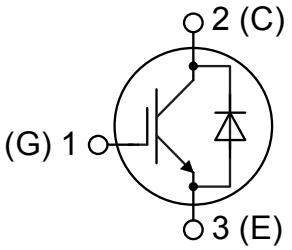
Copack

Part number

IXA4IF1200TC



Backside: collector



Features / Advantages:

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Rugged XPT design (Xtreme light Punch Through) results in:
  - short circuit rated for 10 µsec.
  - very low gate charge
  - low EMI
  - square RBSOA @ 3x Ic
- Thin wafer technology combined with the XPT design results in a competitive low VCE(sat)
- SONIC™ diode
  - fast and soft reverse recovery
  - low operating forward voltage

Applications:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

Package: TO-268AA (D3Pak)

- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

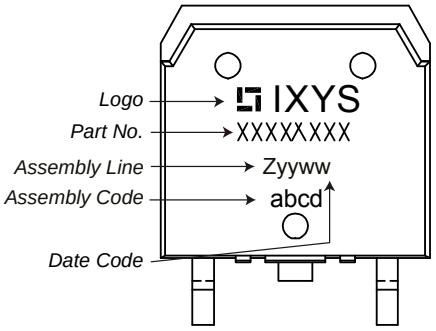
preliminary

IGBT				Ratings			
Symbol	Definition	Conditions		min.	typ.	max.	Unit
V_{CES}	*collector emitter voltage*		T_{VJ} = 25°C			1200	V
V_{GES}	*max. DC gate voltage*					±20	V
V_{GEM}	*max. transient gate emitter voltage*					±30	V
I_{C25}	*collector current*		T_C = 25°C			9	A
I_{C100}			T_C = 100°C			5	A
P_{tot}	*total power dissipation*		T_C = 25°C			45	W
$V_{CE(sat)}$	*collector emitter saturation voltage*	I_C = 3A; V_{GE} = 15 V	T_{VJ} = 25°C		1.8	2.1	V
			T_{VJ} = 125°C		2.1		V
$V_{GE(th)}$	*gate emitter threshold voltage*	I_C = 0.1mA; V_{GE} = V_{CE}	T_{VJ} = 25°C	5.4	5.9	6.5	V
I_{CES}	*collector emitter leakage current*	V_{CE} = V_{CES}; V_{GE} = 0 V	T_{VJ} = 25°C			0.1	mA
			T_{VJ} = 125°C		0.1		mA
I_{GES}	*gate emitter leakage current*	V_{GE} = ±20 V				500	nA
$Q_{G(on)}$	*total gate charge*	V_{CE} = 600 V; V_{GE} = 15 V; I_C = 3 A			12		nC
$t_{d(on)}$	*turn-on delay time*				70		ns
t_r	*current rise time*				40		ns
$t_{d(off)}$	*turn-off delay time*	inductive load	T_{VJ} = 125°C		250		ns
t_f	*current fall time*	V_{CE} = 600 V; I_C = 3 A			100		ns
E_{on}	*turn-on energy per pulse*	V_{GE} = ±15 V; R_G = 330 Ω			0.4		mJ
E_{off}	*turn-off energy per pulse*				0.3		mJ
RBSOA	*reverse bias safe operating area*	V_{GE} = ±15 V; R_G = 330 Ω	T_{VJ} = 125°C				
I_{CM}		V_{CEmax} = 1200 V				9	A
SCSOA	*short circuit safe operating area*	V_{CEmax} = 900 V					
t_{SC}	*short circuit duration*	V_{CE} = 900 V; V_{GE} = ±15 V	T_{VJ} = 125°C			10	µs
I_{SC}	*short circuit current*	R_G = 330 Ω; non-repetitive			12		A
R_{thJC}	*thermal resistance junction to case*					2.7	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.15		K/W
Diode							
V_{RRM}	*max. repetitive reverse voltage*		T_{VJ} = 25°C			1200	V
I_{F25}	*forward current*		T_C = 25°C			10	A
I_{F100}			T_C = 100°C			6	A
V_F	*forward voltage*	I_F = 3A	T_{VJ} = 25°C			2.20	V
			T_{VJ} = 125°C		1.90		V
I_R	*reverse current*	V_R = V_{RRM}	T_{VJ} = 25°C			*	mA
	* not applicable, see Ices value above		T_{VJ} = 125°C		*		mA
Q_{rr}	*reverse recovery charge*	V_R = 600 V			0.5		µC
I_{RM}	*max. reverse recovery current*	-di_F/dt = -150 A/µs	T_{VJ} = 125°C		5		A
t_{rr}	*reverse recovery time*	I_F = 3A; V_{GE} = 0 V			350		ns
E_{rec}	*reverse recovery energy*				0.1		mJ
R_{thJC}	*thermal resistance junction to case*					3	K/W
R_{thCH}	*thermal resistance case to heatsink*				0.15		K/W

preliminary

Package TO-268AA (D3Pak)			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	*RMS current*	per terminal			70	A
T_{VJ}	*virtual junction temperature*		-40		150	°C
T_{op}	*operation temperature*		-40		125	°C
T_{stg}	*storage temperature*		-40		150	°C
Weight				5		g
F_C	*mounting force with clip*		20		120	N

Product Marking



Part number

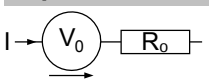
I = IGBT
X = XPT IGBT
A = Gen 1 / std
4 = Current Rating [A]
IF = Copack
1200 = Reverse Voltage [V]
TC = TO-268AA (D3Pak) (2)

Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	IXA4IF1200TC	IXA4IF1200TC	Tube	30	510224

Similar Part	Package	Voltage class
IXA4IF1200UC	TO-252AA (DPak)	1200

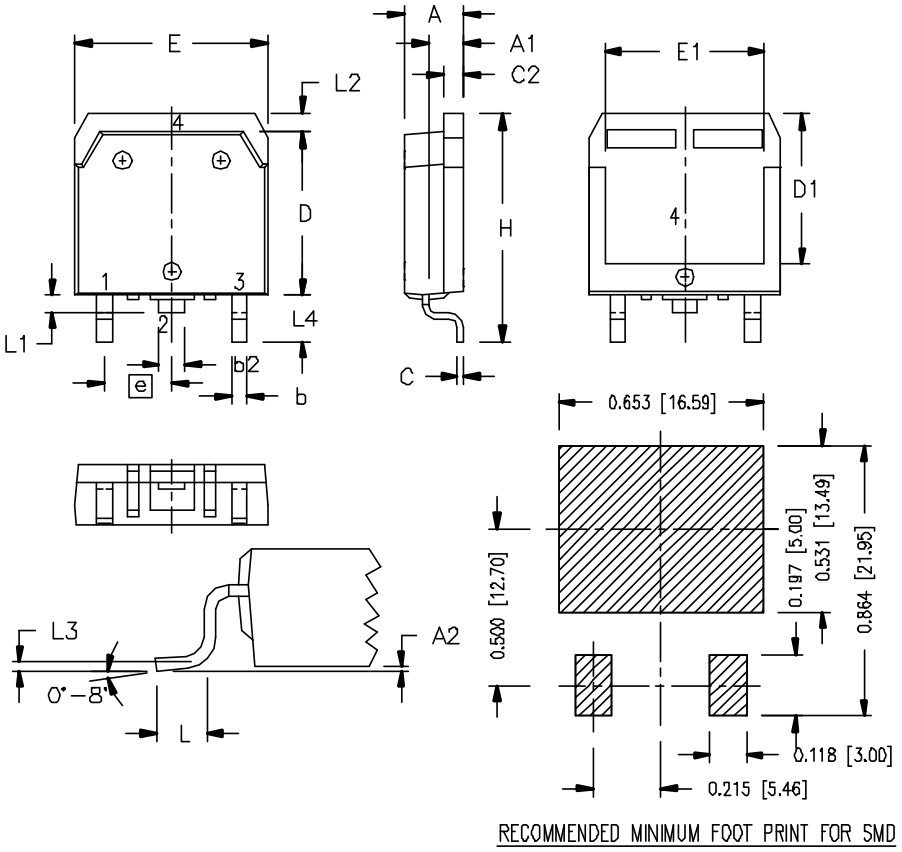
Equivalent Circuits for Simulation

** on die level* T_{VJ} = 150 °C



		IGBT	Diode	
$V_{0\,max}$	*threshold voltage*	1.1	1.25	V
$R_{0\,max}$	*slope resistance **	460	280	mΩ

Outlines TO-268AA (D3Pak)



Dim.	Millimeter		Inches	
	min	max	min	max
A	4.90	5.10	0.193	0.201
A1	2.70	2.90	0.106	0.114
A2	0.02	0.25	0.001	0.100
b	1.15	1.45	0.045	0.057
b2	1.90	2.10	0.075	0.083
C	0.40	0.65	0.016	0.026
C2	1.45	1.60	0.057	0.063
D	13.80	14.00	0.543	0.551
D1	12.40	12.70	0.488	0.500
E	15.85	16.05	0.624	0.632
E1	13.30	13.60	0.524	0.535
e	5.45 BSC		0.215 BSC	
H	18.70	19.10	0.736	0.752
L	2.40	2.70	0.094	0.106
L1	1.20	1.40	0.047	0.055
L2	1.00	1.15	0.039	0.045
L3	0.25 BSC		0.100 BSC	
L4	3.80	4.10	0.150	0.161